### PATENT ASSIGNMENT

# Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Ji Hwan PARK	06/30/2009

### **RECEIVING PARTY DATA**

Name:	Dongbu HiTek Co., Ltd.	
Street Address:	891-10 Daechi-dong, Gangnam-gu	
City:	Seoul	
State/Country:	KOREA, REPUBLIC OF	
Postal Code:	135-280	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12501784

### CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: SPO200906-0012US

NAME OF SUBMITTER: Andrew D. Fortney, Reg. No. 34,600

Total Attachments: 1

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OP \$40.00 1250178

PATENT REEL: 022947 FRAME: 0120 Attorney Docket No.: SPO200906-0012US

### ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

## Ji Hwan PARK

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled;

Method of Manufacturing Image Sensor
Do hereby sell, assign and transfer to Dongbu HiTek Co., Ltd.  of Republic of Korea , having a place of business at 891-10, Daechi-dong, Gangnam-gu, Seoul 135-280 / Republic of Korea its successors, assigns, and legal representatives, the full and exclusive right to said invention and said
application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, fitle and interest in end to any and all Letters Patent which may be granted therefor in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties;
Agree that Dongth HiTek Co., Ltd. , hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and
Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.
IN TESTIMONY WHEREOF I have hereunto set MY signature on the date indicated below,
Full Name of Sole/First Inventor:
Ji Hwan PARK
Inventor's Signature: Date: Month/Day/Year
Johnson Park Jame 170/2001
Full Name of Second Inventor, if any:
Inventor's Signature: Date: Month/Day/Year

Customer No. 36872

**RECORDED: 07/13/2009** 

**PATENT REEL: 022947 FRAME: 0121**